TOSHIBA PHOTOCOUPLER

TLP250(D4), TLP250F(D4), TLP251(D4), TLP251F(D4)

<u>ATTACHMENT</u>: SPECIFICATIONS FOR <u>VDE0884</u> OPTION: (D4)

Types: TLP250, TLP251 TLP250F, TLP251F

Type designations for 'Option: (D4)', which are tested under VDE0884 requirements.

LF4: standard lead bend

Note : Use Toshiba standard type number for safety standard application.

Ex. TLP250F (D4-LF4) \rightarrow TLP250F

VDE0884 ISOLATION CHARACTERISTICS

DESCRIPTION			SYMBOL	RATING	UNIT
Application Classification (DIN VDE0110 Teil 2/01.89, Table 1) for rated mains voltage≤300 V _{RMS} for rated mains voltage≤600 V _{RMS}				I- Ⅲ I- Ⅱ	_
Climatic Classification (DIN IEC68 Teil 1/09.80)				40 / 100 / 21	_
Pollution Degree (DIN VDE0110 Teil 2/01.89)				2	_
Maximum Operating Insulation Voltage	TLPxxx TLPxxxF	type type	V _{IORM}	630 1140	Vpk
Input to output Test Voltage, Method A $ Vpr\!=\!1.5\!\times\!V_{\mbox{IORM}}, \mbox{Type and Sample Test} \\ t_{p}\!=\!60s, \mbox{Partial Discharge}\!<\!5pC $	TLPxxx	type	Vpr	945	Vpk
	TLPxxxF	type		1710	
Input to output Test Voltage, Method B $ \begin{array}{c} \text{Vpr}\!=\!1.875\!\times\!\text{V}_{\mbox{IORM}},\ 100\%\ \mbox{Production Test} \\ t_{\mbox{p}}\!=\!1\text{s},\ \mbox{Partial Discharge}\!<\!5\text{pC} \end{array} $	TLPxxx	type	Vpr	1180	Vpk
	TLPxxxF	type		2140	
Highest Permissible Overvoltage	TLPxxx	type	$ m V_{TR}$	4000	Vpk
(Transient Overvoltage, t _{pr} =10s)	TLPxxxF	type		6000	
Safety Limiting Values (Max. permissible rating fault, also refer to thermal derating curve)	gs in case o	f			
Current (Input current IF, Psi=0)			Isi	100	mA
Power (Output or Total Power Dissipation)			Psi	800	mW
Temperature			Tsi	150	°C
Insulation Resistance, $V_{IO} = 500V$, $Ta = 25$ °C $V_{IO} = 500V$, $Ta = Tsi$			Rsi	$\stackrel{\geq}{=} 10^{12} \ \stackrel{\geq}{=} 10^9$	Ω

INSULATION RELATED SPECIFICATIONS

		7.62mm pitch TLPxxx type	10.16mm pitch TLPxxxF type	
Minimum Creepage Distance (*)	Cr	6.4mm	8.0mm	
Minimum Clearance (*)	Cl	6.4mm	8.0mm	
Minimum Insulation Thickness	ti	_		
Comperative Tracking Index (DIN IEC112/VDE0303, Part 1)	CTI	175 (VDE0110 Teil 2/01.89 Group Ⅱa)		

(*) in accordance with DIN VDE0110 Teil 2/01.89, Table 2, & 4

- 1. If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value (e. g. at a standard distance between soldering eye centres of 7.5mm). If this is not permissible, the user shall take suitable measures.
- 2. This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.

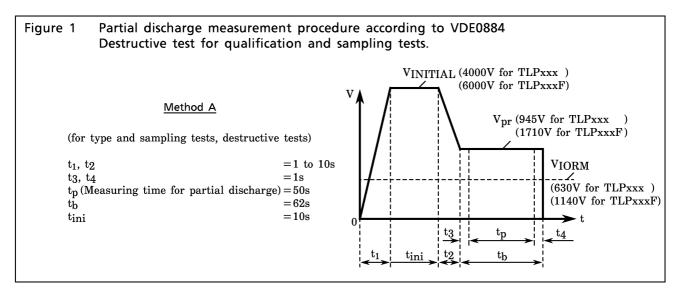
VDE Test sign: Marking on product

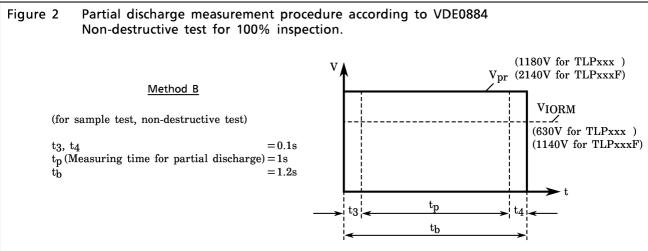
for VDE0884

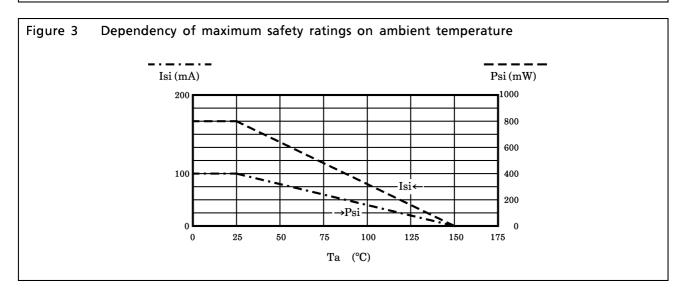


Marking on packing for VDE0884









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